



MIC94001

P-Channel MOSFET

Not Recommended for New Designs

General Description

The MIC94001 is a silicon gate P-channel MOSFET designed for low on-resistance, high-side switch applications. The MIC94001 has a maximum on-resistance of 0.4Ω at 4.5V gate-to-source voltage.

Improved ESD protection is provided by the gate protection network shown in the schematic diagram.

The MIC94001 is supplied in a low-profile version of the 8-lead SOIC package.

The MIC94001 die can be assembled in a 4-terminal configuration with the body not shorted to the source for use in analog switch applications. Contact the factory for more information.

Features

- 15V minimum drain-to-source breakdown
- 0.4Ω maximum on-resistance at 4.5V gate-to-source
- Functional at 2.7V gate-to-source
- 0.063" maximum height

Applications

- High-side switch
- Power management
- Stepper motor control
- 1.8" PCMCIA disk-drive V_{CC} switch

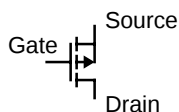
Ordering Information

Part Number	Temperature Range*	Package
MIC94001BLM	-55°C to $+150^{\circ}\text{C}$	8-lead SOIC [†]

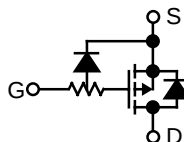
* Operating Junction Temperature

[†] Low Profile Leads, see Package Information

Schematic Information

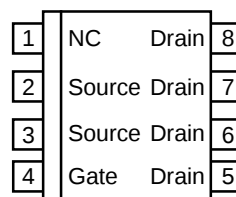


Schematic Symbol



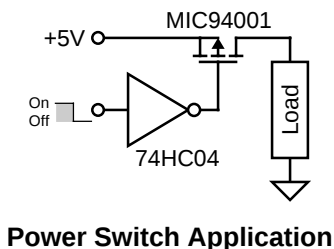
Schematic Diagram

Pin Configuration



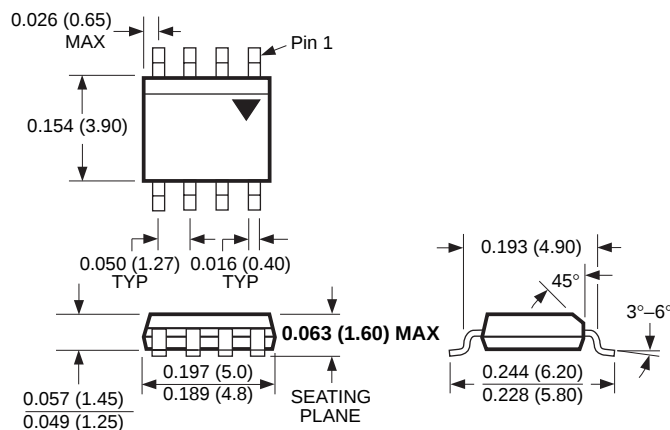
8-lead Low-Profile SOIC Package (LM)

Typical Application



Power Switch Application

Package Information



Absolute Maximum Ratings

Voltage and current values are negative. Signs not shown for clarity.

Drain-to-Source Voltage	15V
Gate-to-Source Voltage	15V
Continuous Drain Current	
$T_A = 25^\circ\text{C}$	1.6A
$T_A = 100^\circ\text{C}$	1A
Operating Junction Temperature	-55°C to $+150^\circ$
Storage Temperature	-55°C to $+150^\circ\text{C}$

Total Power Dissipation

$T_A = 25^\circ\text{C}$	1W
$T_A = 100^\circ\text{C}$	0.4W

Thermal Resistance

θ_{JA}	125°C/W
θ_{JC}	76°C/W

Lead Temperature

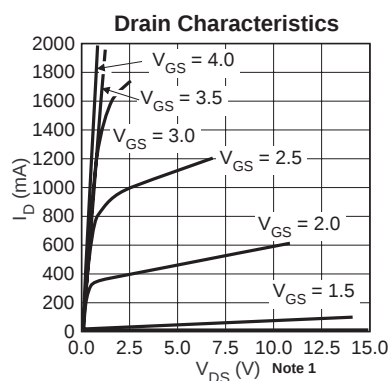
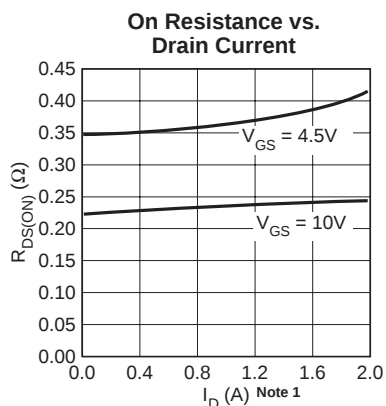
1/16" from case, 10s	$+300^\circ\text{C}$
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Electrical Characteristics $T_A = 25^\circ\text{C}$ unless noted. All values are negative. Signs not shown for clarity.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{BDSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$	15			V
V_{GS}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250\mu\text{A}$	1		3	V
I_{GSS}	Gate-Body Leakage	$V_{DS} = 0\text{V}$, $V_{GS} = 15\text{V}$, Note 2			100	nA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 15\text{V}$, $V_{GS} = 0\text{V}$			25	μA
		$V_{DS} = 15\text{V}$, $V_{GS} = 0\text{V}$, $T_J = 125^\circ\text{C}$			250	μA
$I_{D(ON)}$	On-State Drain Current	$V_{DS} \geq 10\text{V}$, $V_{GS} = 10\text{V}$, Note 1		5.5		A
$R_{DS(ON)}$	Drain-Source On-State Resist.	$V_{GS} = 4.5\text{V}$, $I_D = 50\text{mA}$		0.35	0.40	Ω
g_{FS}	Forward Transconductance	$V_{DS} = 15\text{V}$, $I_D = 1\text{A}$, Note 1		0.7		S

Note 1: Pulse Test: Pulse Width $\leq 300\mu\text{sec}$, Duty Cycle $\leq 2\%$

Note 2: ESD gate protection diode conducts during positive gate-to-source voltage excursions.



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www.DatasheetCatalog.com

Datasheets for electronic components.